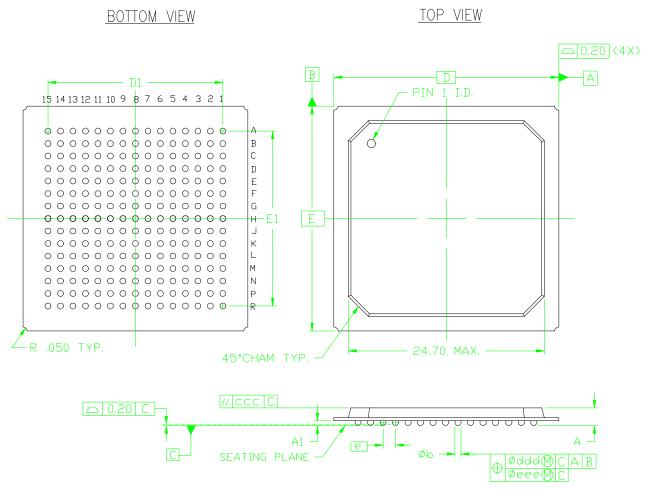
## Plastic BGA (BG225) Package



S Y M B	MILLIMETERS		
L	MIN.	NDM.	MAX.
А	4	2.15	2,55
Α1	0.50	0,60	0.70
D/E	27.00 BSC		
D <sub>1</sub> /E <sub>1</sub>	21.00 REF.		
е	1.50 BSC		
Øb	0.60	0.75	0.90
CCC	4	4	0.35
ddd	4	4	0,30
666	4	4	0.15
М	15		

## NOTES:

- 1. ALL DIMENSIONING AND TOLERANCING CONFORM TO ANSI Y14.5M-1994
- 2. SYMBOL "M" IS THE PIN MATRIX SIZE.
- 3. CONFORMS TO JEDEC MO-151-CAL (DEPOPULATED)

## 225-BALL PLASTIC BGA (BG225)

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